

## N-CHANNEL SILICON POWER MOSFET

## FAP-IIA SERIES

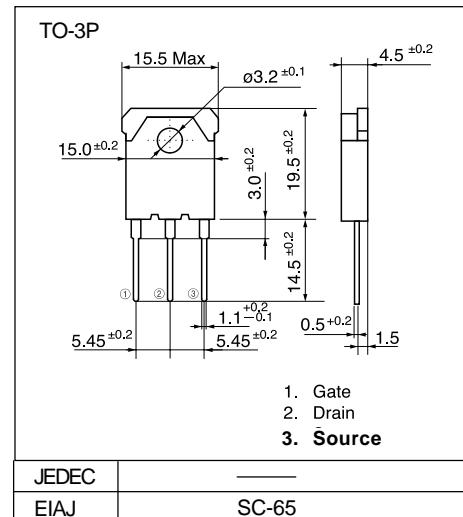
## ■ Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- High voltage
- $V_{GS} = \pm 30V$  Guarantee
- Avalanche-proof

## ■ Applications

- Switching regulators
- UPS
- DC-DC converters
- General purpose power amplifier

## ■ Outline Drawings



## ■ Maximum ratings and characteristics

● Absolute maximum ratings ( $T_c = 25^\circ C$  unless otherwise specified)

Item	Symbol	Rating	Unit
Drain-source voltage	$V_{DS}$	500	V
Continuous drain current	$I_D$	12	A
Pulsed drain current	$I_{D(puls)}$	48	A
Continuous reverse drain current	$I_{DR}$	12	A
Gate-source peak voltage	$V_{GS}$	$\pm 30$	V
Max. power dissipation	$P_D$	125	W
Operating and storage temperature range	$T_{ch}$	+150	$^\circ C$
	$T_{stg}$	-55 to +150	$^\circ C$

● Electrical characteristics ( $T_c = 25^\circ C$  unless otherwise specified)

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 1mA$ $V_{GS} = 0V$	500			V
Gate threshold voltage	$V_{GS(th)}$	$I_D = 1mA$ $V_{DS} = V_{GS}$	2.5	3.0	3.5	V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 500V$ $V_{GS} = 0V$	$T_{ch} = 25^\circ C$	10	500	$\mu A$
				0.2	1.0	mA
Gate-source leakage current	$I_{GSS}$	$V_{GS} = \pm 30V$ $V_{DS} = 0V$	10	100	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$I_D = 6A$ $V_{GS} = 10V$		0.45	0.60	$\Omega$
Forward transconductance	$G_{fs}$	$I_D = 6A$ $V_{DS} = 25V$	5.0	10.0		S
Input capacitance	$C_{iss}$	$V_{DS} = 25V$		2200	3300	$pF$
Output capacitance	$C_{oss}$	$V_{GS} = 0V$		230	345	
Reverse transfer capacitance	$C_{rss}$	$f = 1MHz$		55	85	
Turn-on time $t_{on}$	$t_{d(on)}$	$V_{CC} = 300V$ $R_G = 10\Omega$	25	40		ns
( $t_{on} - t_{d(on)} + t_r$ )	$t_r$	$I_D = 12A$	55	85		
Turn-off time $t_{off}$	$t_{d(off)}$	$V_{GS} = 10V$	110	165		
( $t_{off} - t_{d(off)} + t_r$ )	$t_f$		60	90		
Avalanche capability	$I_{AV}$	$L = 100\mu H$ $T_{ch} = 25^\circ C$	12			A
Diode forward on-voltage	$V_{SD}$	$I_F = 2 \times I_{DR}$ $V_{GS} = 0V$ $T_{ch} = 25^\circ C$		1.3	1.95	V
Reverse recovery time	$t_{rr}$	$I_F = I_{DR}$ $V_{GS} = 0V$		400		ns
Reverse recovery charge	$Q_{rr}$	$-di/dt = 100A/\mu s$ $T_{ch} = 25^\circ C$		3		$\mu C$

## ● Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	$R_{th(ch-a)}$	channel to ambient			35.0	$^\circ C/W$
	$R_{th(ch-c)}$	channel to case			1.00	$^\circ C/W$

## ■ Characteristics

